

Rev. V1

#### **Features**

- +42 dBm Output IP3
- · Broadband Operation
- Lead-Free SOT-89 Package
- Halogen-Free "Green" Mold Compound
- RoHS\* Compliant and 260°C Reflow Compatible
- Class 2 ESD Rating

## **Description**

The MAAM-009286 RF driver amplifier is a GaAs MMIC which exhibits exceptional linearity, as well as high gain in a lead-free SOT-89 surface mount plastic package. Broadband operation over the 250 to 4000 MHz range is achieved using external matching components as shown in the PCB layout. Different component values may be needed to optimize performance at different center frequencies. The device is biased with a single +5 volt supply and consumes 155 mA typically.

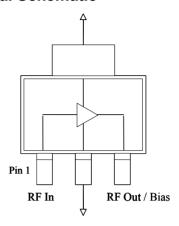
The MAAM-009286 is fabricated using an HBT process to realize low current and high linearity. The process features full passivation for increased performance and reliability.

# Ordering Information<sup>1,2</sup>

Part Number	Package
MAAM-009286-000000	Bulk Packaging
MAAM-009286-TR3000	3000 piece reel
MAAM-009286-001SMB	Sample Board

- 1. Reference Application Note M513 for reel size information.
- 2. All sample boards include 5 loose parts.

### **Functional Schematic**



## **Pin Configuration**

Pin No.	Function	Pin No.	Function
1	RF Input	3	RF Output/Bias
2	Ground		

# Maximum Operating Conditions<sup>3</sup>

Parameter	Maximum Operating Conditions	
Junction Temperature 4	170°C	
RF Output Power	27 dBm	
Operating Temperature	-40°C to +85°C	

- 3. These operating conditions will ensure MTTF > 1 x  $10^6$  hours.
- 4. Junction Temperature  $(T_J) = T_A + \Theta jc^* ((V * I) (P_{OUT} P_{IN}))$ Typical thermal resistance  $(\Theta jc) = 70^\circ$  C/W a) For  $T_A = 25^\circ$ C,

 $^{T}\rm J_J$  = 76 °C @ 5 V, 170 mA,  $P_{OUT}$  = 21 dBm,  $P_{IN}$  = 5.5 dBm b) For  $T_A$  = 85°C,

 $T_J$  = 125 °C @ 5 V, 140 mA,  $P_{OUT}$  = 21 dBm,  $P_{IN}$  = 6.2 dBm

# Absolute Maximum Ratings<sup>5,6</sup>

Parameter	Absolute Maximum
RF Output Power	28 dBm
Voltage	6 volts
Storage Temperature	-65°C to +150°C
Junction Temperature	210°C

- 5. Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM Technology does not recommend sustained operation near these survivability limits.

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<sup>\*</sup> Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

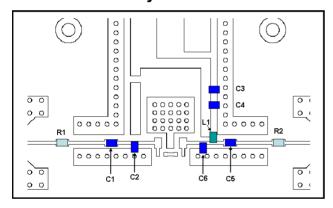


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# Electrical Specifications: Freq. = 2140 MHz, $T_A$ = +25°C, $V_{CC}$ = +5 V, $Z_0$ = 50 $\Omega$

Parameter	Units	Min.	Тур.	Max.
Gain	dB	14	15.5	_
Noise Figure	dB	_	3.5	_
Input Return Loss	dB	_	11	_
Output Return Loss	dB	_	13	_
Output P1dB	dBm	_	27	_
Output IP3 P <sub>IN</sub> = -6 dBm / tone, 1 MHz spacing	dBm	40	42	_
Quiescent Current	mA	_	155	_
Current (P <sub>IN</sub> = -3 dBm)	mA	_	155	225

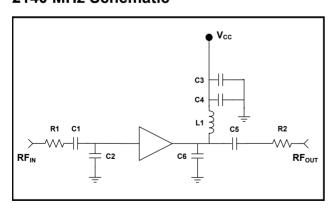
## 2140 MHz PCB Layout



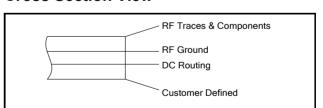
## **Parts List**

Part	Value	Case Style
C1	12 pF	0402
C2	2.2 pF	0402
C3	0.1 μF	0402
C4	1000 pF	0402
C5	39 pF	0402
C6	1.2 pF	0402
L1	7.5 nH	0402
R1, R2	0 Ω	0402

### 2140 MHz Schematic



### **Cross Section View**



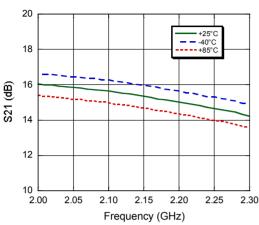
The PCB dielectric between RF traces and RF ground layers should be chosen to reduce RF discontinuities between 50  $\Omega$  lines and package pins. M/A-COM recommends an FR-4 dielectric thickness of 0.008" (0.20 mm) yielding a 50  $\Omega$  line width of 0.015" (0.38 mm). The recommended RF metalization is 1 ounce copper.



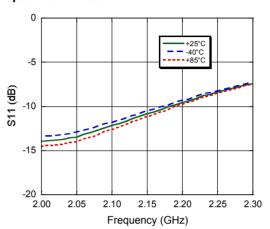
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# **Typical Performance Curves, 2140 MHz Configuration**

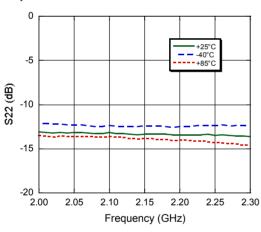
## Gain



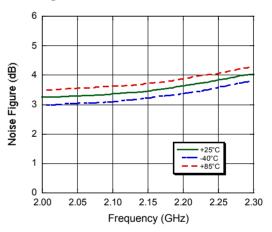
#### Input Return Loss



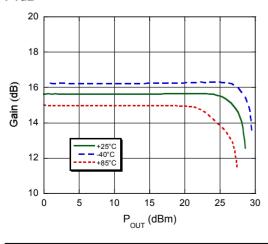
#### **Output Return Loss**



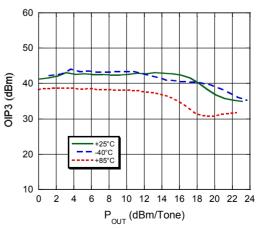
#### Noise Figure



#### P1dB



## **Output IP3**

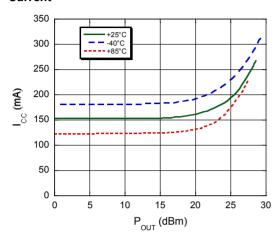




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## Typical Performance Curves, 2140 MHz Configuration

#### Current



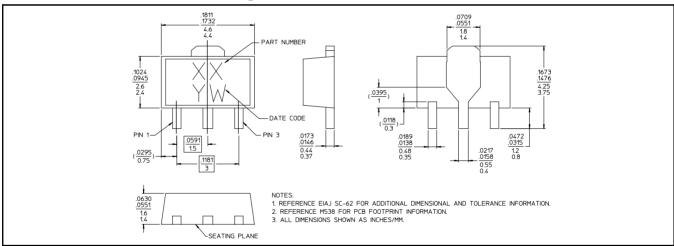
## **Handling Procedures**

Please observe the following precautions to avoid damage:

## **Static Sensitivity**

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these class 2 devices.

# Lead-Free SOT-89 Plastic Package<sup>†</sup>



<sup>†</sup> Reference Application Note M538 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is 100% matte tin over copper.